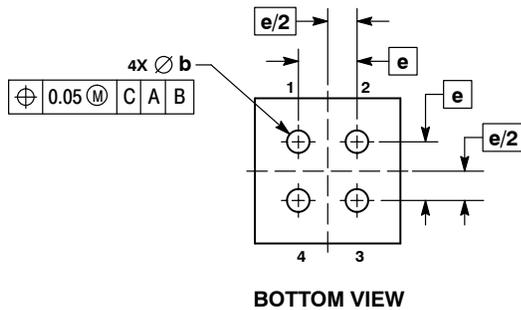
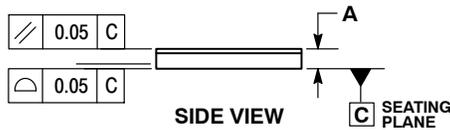
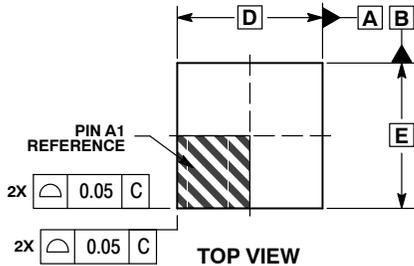




SCALE 4:1

XFLGA4 1.61x1.61  
CASE 614AB  
ISSUE O

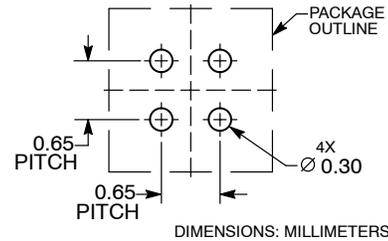
DATE 16 APR 2013



- NOTES:
1. DIMENSIONING AND TOLERANCING PER ASME Y14.5M, 1994.
  2. CONTROLLING DIMENSION: MILLIMETERS.

MILLIMETERS		
DIM	MIN	MAX
A	0.20	0.24
b	0.27	0.33
D	1.61 BSC	
E	1.61 BSC	
e	0.65 BSC	

RECOMMENDED  
SOLDERING FOOTPRINT\*



\*For additional information on our Pb-Free strategy and soldering details, please download the **onsemi** Soldering and Mounting Techniques Reference Manual, SOLDERRM/D.

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DESCRIPTION:	XFLGA4 1.61X1.61	PAGE 1 OF 1

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